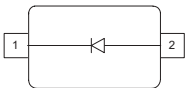


### Silicon Schottky Diode

- High current rectifier Schottky diode with extreme low  $V_F$  drop (typ. 0.12V at  $I_F = 10\text{mA}$ )
- For power supply applications
- For clamping and protection in low voltage applications
- For detection and step-up-conversion
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



### BAT60A



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Package	Configuration	Marking
BAT60A	SOD323	single	white/3

**Maximum Ratings** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage <sup>2)</sup>	$V_R$	10	V
Forward current	$I_F$	3	A
Non-repetitive peak surge forward current ( $t \leq 10\text{ms}$ )	$I_{FSM}$	5	
Total power dissipation $T_S \leq 28^\circ\text{C}$	$P_{tot}$	1350	mW
Junction temperature	$T_j$	150	°C
Operating temperature range	$T_{op}$	-55 ... 85	
Storage temperature	$T_{stg}$	-55 ... 150	

<sup>1)</sup>Pb-containing package may be available upon special request

<sup>2)</sup>For  $T_A > 25^\circ\text{C}$  the derating of  $V_R$  has to be considered. Please refer to curve Permissible reverse voltage.

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	$\leq 90$	K/W

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

Reverse current <sup>2)</sup>	$I_R$				mA
$V_R = 5\text{ V}$		-	0.3	1	
$V_R = 8\text{ V}$		-	0.6	2.6	
$V_R = 5\text{ V}, T_A = 80^\circ\text{C}$		-	18	-	
Forward voltage <sup>2)</sup>	$V_F$				V
$I_F = 10\text{ mA}$		0.1	0.12	0.15	
$I_F = 100\text{ mA}$		0.15	0.2	0.23	
$I_F = 1000\text{ mA}$		0.22	0.3	0.37	

**AC Characteristics**

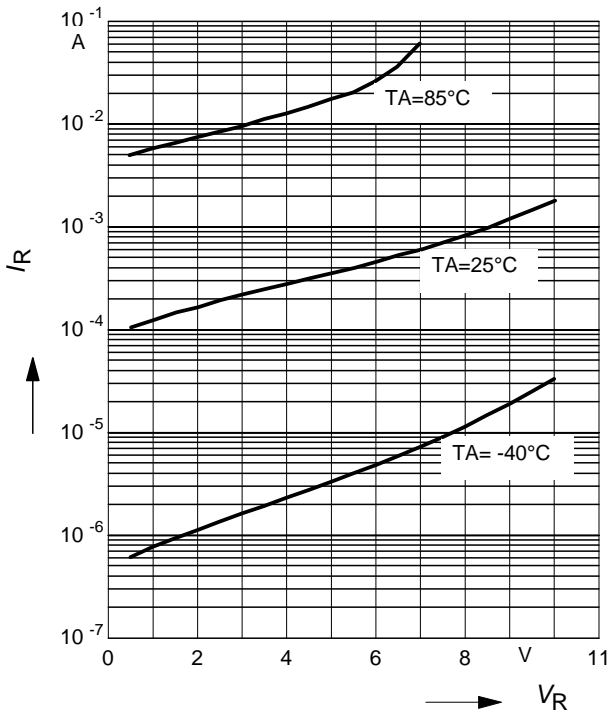
Diode capacitance	$C_T$	-	20	35	pF
$V_R = 5\text{ V}, f = 1\text{ MHz}$					

<sup>1</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

<sup>2</sup>Pulsed test:  $t_p = 300\ \mu\text{s}; D = 0.01$

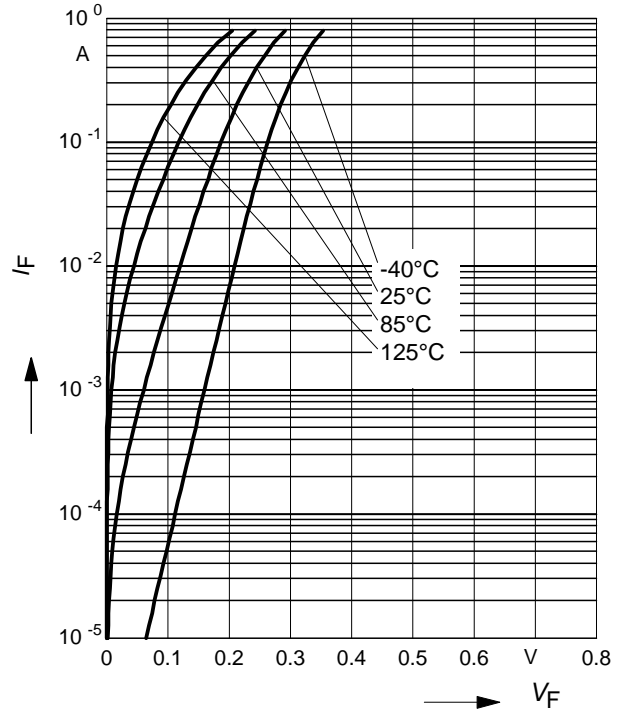
**Reverse current  $I_R = f(V_R)$**

$T_A = \text{Parameter}$



**Forward current  $I_F = f(V_F)$**

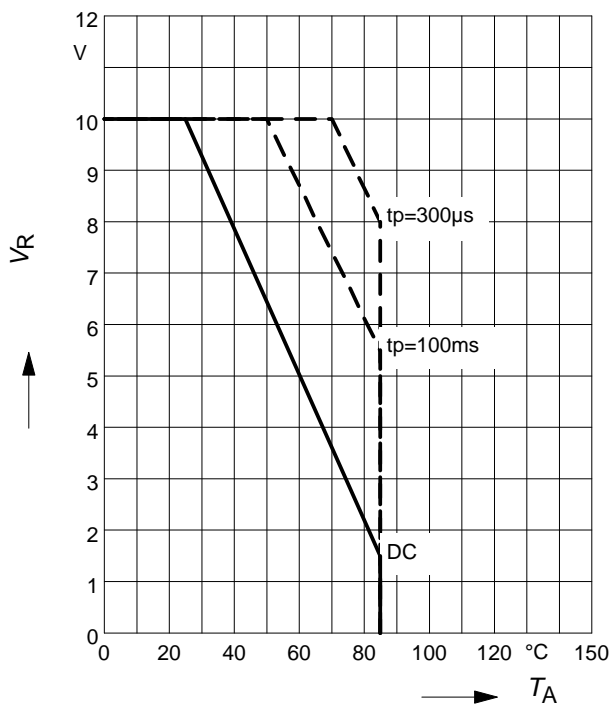
$T_A = \text{Parameter}$



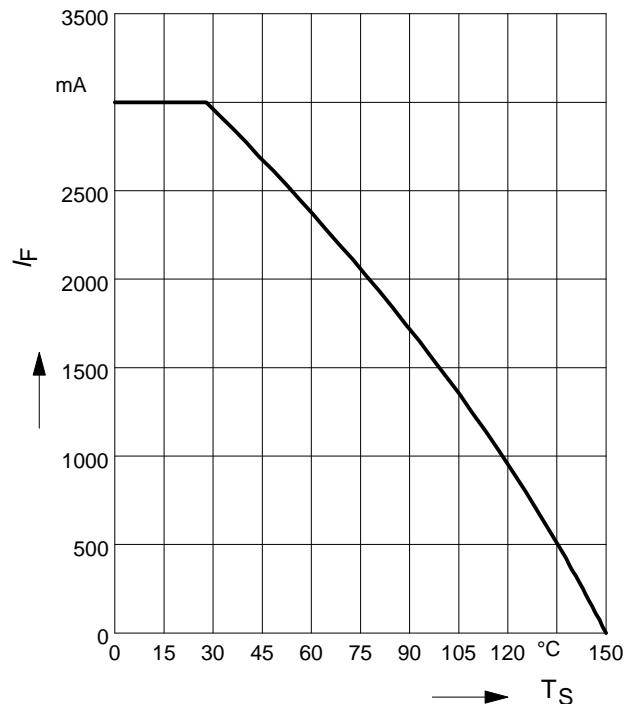
**Permissible Reverse voltage  $V_R = f(T_A)$**

$t_p = \text{Parameter}$ ; duty cycle  $< 0.01$

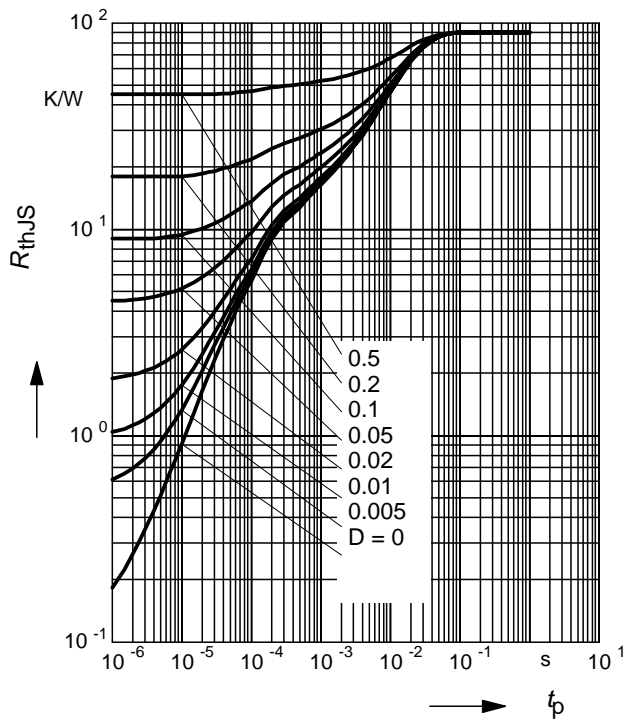
Device mounted on PCB with  $R_{th} = 160 \text{ K/W}$



**Forward current  $I_F = f(T_S)$**

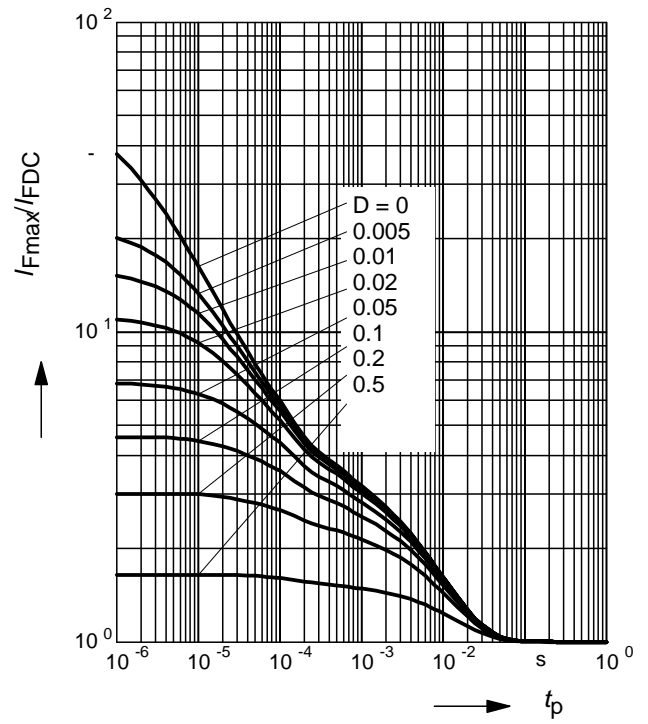


Permissible Puls Load  $R_{thJS} = f(t_p)$



Permissible Pulse Load

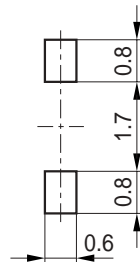
$I_{Fmax} / I_{FDC} = f(t_p)$



Package Outline



Foot Print



Marking Layout (Example)



Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



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